# **UNITED STATES** SECURITIES AND EXCHANGE COMMISSION

Washington, D.C. 20549

# FORM 8-K

### **CURRENT REPORT**

Pursuant to Section 13 OR 15(d) of The Securities Exchange Act of 1934

April 2, 2009

Date of Report (date of earliest event reported)

# MICRON TECHNOLOGY, INC. (Exact name of registrant as specified in its charter)

**Delaware** 1-10658 75-1618004 (Commission File Number) (I.R.S. Employer Identification No.) (State or other jurisdiction of incorporation) 8000 South Federal Way Boise, Idaho 83716-9632

(Address of principal executive offices)

(208) 368-4000

(Registrant's telephone number, including area code)

Check the appropriate box below if the Form 8-K filing is intended to simultaneously satisfy the filing obligation of the registrant under any of the following provisions (see General Instruction A.2. below):

- O Written communications pursuant to Rule 425 under the Securities Act (17 CFR 230.425)
- O Soliciting material pursuant to Rule 14a-12 under the Exchange Act (17 CFR 240.14a-12)
- O Pre-commencement communications pursuant to Rule 14d-2(b) under the Exchange Act (17 CFR 240.14d-2(b))
- o Pre-commencement communications pursuant to Rule 13e-4(c) under the Exchange Act (17 CFR 240.13e-4c))

#### Item 2.02. Results of Operations and Financial Condition.

On April 2, 2009, the Company announced its financial results for the fiscal quarter ended March 5, 2009. The full text of the press release issued in connection with the announcement is attached as Exhibit 99.1 to this Current Report on Form 8-K.

#### Item 2.05. Costs Associated with Exit or Disposal Activities.

In response to a severe downturn in the semiconductor memory industry and global economic conditions, the Company initiated restructure plans in 2009. In the first quarter of 2009, IM Flash, a joint venture between the Company and Intel, terminated its agreement with the Company to obtain NAND Flash memory supply from the Company's Boise facility, reducing the Company's NAND Flash production by approximately 35,000 200mm wafers per month. In addition, the Company and Intel agreed to suspend tooling and the ramp of NAND Flash production at IM Flash's Singapore wafer fabrication facility. On February 23, 2009, the Company announced that it will phase out all remaining 200mm wafer manufacturing operations at its Boise, Idaho, facility, reducing employment there by as many as 2,000 positions by the end of fiscal 2009.

As a result of these actions, the Company recorded a net \$66 million credit to restructure in the first quarter of fiscal 2009 and a restructure charge of \$105 million in the second quarter of fiscal 2009, primarily attributable to the Company's Memory segment. The net credit in the first quarter of fiscal 2009 includes a \$144 million gain in connection with the termination of the NAND Flash supply agreement, charges of \$56 million to reduce the carrying value of certain 200mm wafer manufacturing equipment at its Boise, Idaho facility and charges of \$22 million for severance and other termination benefits. The charge in the second quarter of fiscal 2009 includes charges of \$87 million to reduce the carrying value of certain 200mm wafer manufacturing equipment at its Boise, Idaho facility and charges of \$17 million for severance and other termination benefits. Excluding any gains or losses from sales of equipment, the Company expects to incur additional restructure costs through fiscal 2009 of approximately \$27 million, comprised primarily of severance and other employee related costs.

#### Item 9.01. Financial Statements and Exhibits.

(d) Exhibits.

The following exhibits are filed herewith:

## Exhibit No. Description

99.1 Press Release issued on April 2, 2009

## **SIGNATURE**

Pursuant to the requirements of the Securities Exchange Act of 1934, the Registrant has duly caused this report to be signed on its behalf by the undersigned hereunto duly authorized.

## MICRON TECHNOLOGY, INC.

April 2, 2009 By: <u>/s/ Ronald C. Foster</u>

Date:

Name:Ronald C. Foster

Title: Chief Financial Officer and Vice President of Finance

# INDEX TO EXHIBITS FILED WITH THE CURRENT REPORT ON FORM 8-K DATED APRIL 2, 2009

Exhibit	Description
99.1	Press Release issued on April 2, 2009

#### FOR IMMEDIATE RELEASE

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# MICRON TECHNOLOGY, INC., REPORTS RESULTS FOR THE SECOND QUARTER OF FISCAL 2009

**BOISE, Idaho**, April 2, 2009 – Micron Technology, Inc., (NYSE: MU) today announced results of operations for the company's second quarter of fiscal 2009, which ended March 5, 2009. For the second quarter of fiscal 2009, the company posted a net loss of \$751 million, or \$0.97 per diluted share, on net sales of \$1.0 billion. These results reflect a number of cash and non-cash items resulting in a net charge of \$120 million in the second quarter of fiscal 2009. The company ended the quarter with cash and investments of \$932 million.

The imbalance of supply and demand for semiconductor memory products continued in the second quarter, resulting in significant decreases in the company's per gigabit average selling prices compared to the preceding quarter. Revenue from sales of DRAM products decreased approximately 30 percent in the second quarter compared to the first quarter principally due to a 30 percent decrease in selling prices. Sales volumes for DRAM products remained relatively stable comparing the same periods. Revenue from sales of NAND Flash products decreased 20 percent in the second quarter compared to the first quarter due to a 13 percent decrease in selling prices and an eight percent decrease in sales volume.

Memory production in the second quarter was relatively flat compared to the preceding quarter. Increases in bit production of NAND Flash products resulting from the company's transitions to higher density 34nm NAND Flash products were offset by decreases in production resulting from the company's decision to slow down DRAM production at its 200mm facilities and to discontinue production of 200mm NAND Flash wafers at its Boise facility.

"We are actively managing our overall cost structure, capital expenditures and technology execution, which are driving our operating margins ahead of industry trend lines," said Steve Appleton, Micron Chairman and CEO. "Notably, our 34nm NAND technology is ramping rapidly and is providing a competitive differentiation in this challenging economic environment."

The company's gross margin on sales of memory products improved 11 percent in the second quarter compared to the previous quarter, resulting from decreases in per gigabit manufacturing costs and the benefit in the second quarter from sales of products previously written-down, partially offset by decreases in selling prices. Cost of goods sold includes charges for unused production capacity, including charges from the company's Inotera and IM Flash joint ventures. Excluding the effects of the inventory write-downs and idle capacity charges, per gigabit costs declined significantly for both DRAM and NAND Flash products.

Sales of CMOS image sensors in the second quarter decreased 54 percent compared to the preceding quarter as a result of a sharp decline in unit sales stemming from weakness in consumer markets. The company's gross margin on sales of Imaging products was two percent in the second quarter compared to 29 percent in the first quarter, primarily resulting from higher per unit manufacturing costs associated with a significant decrease in the level of production.

The company's cost-cutting and restructuring activities have yielded reductions in operating costs and contributed to the company's cash flow from operating activities in the second quarter. In addition, the company recently announced that it will phase out the remaining 200mm wafer production at its Boise facility. As a result, the company recorded a restructure charge of \$105 million in the second quarter of fiscal 2009, including \$17 million of employee-related costs and \$87 million of equipment write-downs.

The company will host a conference call today at 2:30 p.m. MDT to discuss its financial results. The call, audio and slides will be available online at www.micron.com. A webcast replay will be available on the company's web site until April 2, 2010. A taped audio replay of the conference call will also be available at (706) 645-9291 (conference number: 90786047) beginning at 5:30 p.m. MDT today and continuing until 5:30 p.m. MDT on April 9, 2009.

Micron Technology, Inc., is one of the world's leading providers of advanced semiconductor solutions. Through its worldwide operations, Micron manufactures and markets DRAM, NAND Flash memory, CMOS image sensors, other semiconductor components, and memory modules for use in leading-edge computing, consumer, networking and mobile products. Micron's common stock is traded on the New York Stock Exchange (NYSE) under the MU symbol. To learn more about Micron Technology, Inc., visit <a href="https://www.micron.com">www.micron.com</a>.

# MICRON TECHNOLOGY, INC. CONSOLIDATED FINANCIAL SUMMARY (in millions except per share data)

	2nd Qtr. Mar. 5, 2009		1st Qtr. Dec. 4, 2008		2nd Qtr. Feb. 28, 2008		x Month Mar. 5, 2009	s En	ded Feb. 28, 2008
	 2003		2000		2000		2005		2000
Net sales	\$ 993	\$	1,402	\$	1,359			\$	2,894
Cost of goods sold (1)	 1,260		1,851		1,402		3,111		2,932
Gross margin	 (267)		(449)		(43	)	(716)		(38)
Selling, general and administrative	90		102		120		192		232
Research and development	168		178		180		346		343
Goodwill impairment (2)	58				463		58		463
Restructure (3)	105		(66)		8		39		21
Other operating (income) expense (4)	 20		9		(42	)	29		(65)
Operating loss	(708)		(672)		(772	)	(1,380)		(1,032)
Interest income (expense), net	(31)		(20)		3		(51)		12
Other non-operating income (expense)	(3)		(9)		(6	)	(12)		(7)
Income tax benefit (provision) (5)	(4)		(13)		4		(17)		(3)
Equity in net losses of equity method									
investees (6)	(56)		(5)				(61)		
Noncontrolling interests in net income	 51		13		(6	)	64		(9)
Net loss	\$ (751)	\$	(706)	\$	(777	) \$	(1,457)	\$	(1,039)
Loss per share:									
Basic	\$ (0.97)	\$	(0.91)	\$	(1.01	) \$	(1.88)	\$	(1.35)
Diluted	(0.97)		(0.91)		(1.01		(1.88)		(1.35)
Number of shares used in per share									
calculations:									
Basic	773.9		773.3		772.4		773.6		772.2
Diluted	773.9		773.3		772.4		773.6		772.2
	2nd		1st (		2nd		Six Mon		
		ır. 5,		c <b>. 4</b> ,	Feb.		Mar. 5,		Feb. 28,
		2009	2	800	2	800	 2009	_	2008
Period-end inventory write-down	\$	234	\$	369	\$	15	\$ 603	\$	77
Estimated net effect of previous write-downs		(277)	•	157)		(50)	(434		(64)
Restructure		105		(66)		8	39		21
Goodwill impairment		58				463	58		463
•	\$	120	\$	146	\$	436	\$ 266	\$	497

### **CONSOLIDATED FINANCIAL SUMMARY, Continued**

	 Mar. 5, 2009	As of Dec. 4, 2008	 Aug. 28, 2008
Cash and short-term investments	\$ 932	\$ 1,028	\$ 1,362
Receivables	654	1,031	1,032
Inventories (1)	859	883	1,291
Total current assets	2,523	3,037	3,779
Property, plant and equipment, net	7,910	8,460	8,811
Total assets (6)	11,526	12,676	13,430
Accounts payable and accrued expenses	950	943	1,111
Current portion of long-term debt	353	343	275
Total current liabilities	1,637	1,635	1,598
Long-term debt	2,542	2,523	2,451
Noncontrolling interests in subsidiaries	2,344	2,702	2,865
Total shareholders' equity	4,742	5,484	6,178

	Six M	Six Months Ended				
	Mar. 5 	•	•			
Net cash provided by operating activities	\$ 69	08 \$ 558	8			
Net cash used for investing activities	(61	.8) (92)	.5)			
Net cash used for financing activities	(39	(11)	7)			
Depreciation and amortization	1,13	1,01	5			
Expenditures for property, plant and equipment	(37	75) (1,30)	6)			
Cash (paid to) received from noncontrolling interests	(44	193	2			
Payments on equipment purchase contracts	(9	08) (27-	4)			
•	·	Ì				
Noncash equipment acquisitions on contracts						
payable and capital leases	17	75 29	7			

The company's second quarters of fiscal 2009 and fiscal 2008 included 13 weeks, while the company's first quarter of fiscal 2009 included 14 weeks. The company's first six months of fiscal 2009 and fiscal 2008 included 27 weeks and 26 weeks, respectively.

- (1) The company's results of operations for the second and first quarters of fiscal 2009 and second quarter of fiscal 2008 include charges of \$234 million, \$369 million and \$15 million, respectively, to write down the carrying value of work in process and finished goods inventories of memory products (both DRAM and NAND Flash) to their estimated market values.
- (2) In the second quarter of fiscal 2009, in accordance with FASB Statement No. 142, "Goodwill and Other Intangible Assets," the company performed a test to determine whether its goodwill associated with its Imaging segment was impaired. Based on the results of the test, the company wrote off all of the \$58 million of goodwill associated with its Imaging segment as of March 5, 2009. Additionally, in the second quarter of fiscal 2008, the company wrote off all of the \$463 million of goodwill associated with its Memory segment as of February 28, 2008.

(3) In the second quarter of fiscal 2009, in response to a sustained severe downturn in the semiconductor memory industry and global economic conditions, the company announced that it would phase out all remaining 200mm wafer manufacturing operations at its Boise, Idaho, facility. The 200mm wafer manufacturing phase-out is expected to reduce employment at the company's Boise facility by as many as 2,000 positions by the end of fiscal 2009. As a result of these actions, the company recorded a restructure charge of \$105 million in the second quarter of fiscal 2009, including \$87 million of equipment impairment charges and \$17 million of severance and other employee related costs.

In the first quarter of fiscal 2009, the company announced a restructuring of its memory operations. As part of the restructure, IM Flash Technologies ("IMFT"), a joint venture between the company and Intel Corporation ("Intel"), terminated its agreement with the company to supply NAND Flash memory from the company's Boise facility, reducing IMFT's NAND Flash production by approximately 35,000 200mm wafers per month. As a result of these actions, the company recorded a net \$66 million credit to restructure in the first quarter of fiscal 2009.

- (4) Other operating (income) expense for the second quarter and first six months of fiscal 2009 include losses of \$29 million and \$43 million, respectively, on disposals of semiconductor equipment. Other operating (income) expense for the second quarter and first six months of fiscal 2008 includes gains of \$47 million and \$57 million, respectively, on disposals of semiconductor equipment and a gain of \$38 million in receipts from the U.S. government in connection with anti-dumping tariffs, received in the first quarter of fiscal 2008.
- (5) Income taxes for fiscal 2009 and 2008 primarily reflect taxes on the company's non-U.S. operations and U.S. alternative minimum tax. The company has a valuation allowance for its net deferred tax asset associated with its U.S. operations. Tax attributable to U.S. operations in fiscal 2009 and 2008 were substantially offset by changes in the valuation allowance.
- (6) In the first quarter of fiscal 2009, the company acquired from Qimonda AG approximately 35.5% of the outstanding common stock of Inotera Memories, Inc. ("Inotera") in a series of transactions for \$398 million. The company's results of operations for the second quarter of fiscal 2009 include a \$56 million net loss on equity method investments for the Company's share of Inotera's loss from the acquisition date to December 31, 2008. The carrying value of the company's investment in Inotera as of March 5, 2009 was \$323 million.

In connection with the acquisition, the company entered into a loan agreement with Nan Ya Plastics Corporation ("NPC"), pursuant to which NPC made a loan to the company in the principal amount of \$200 million, the proceeds of which were used to pay for a portion of the purchase price of the shares in Inotera. In addition, the company entered into a loan agreement with Inotera, pursuant to which Inotera made a loan to the company in the principal amount of \$85 million, the proceeds of which are to be used for general corporate purposes. The loans were recorded at their fair values and reflect an aggregate discount of \$31 million from their face amounts. The aggregate discount was reflected as a reduction in the basis of the company's investment in Inotera.